

04-16-2002



PATENT Docket # 2011037

102056878 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

1. Assignor:

Jason CHUANG, Allis CHEN, Jachson HSIEH, Hsiu Wen TU, Meng Ru TSAI, Mon Nan HO, Fu Yung HUANG, Yung Sheng

CHIU, Jichen WU, and Chih Cheng HSU

Assignee:

KINGPAK TECHNOLOGY INC.

No. 84, Taiho Rd., Chupei

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3. Nature of Conveyance: Assignment of patent

Reference number: Application filed herewith.

Correspondence to:

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PRO-TECHTOR INTERNATIONAL

20775 Norada Court

Saratoga, CA 95070-3018

6. Number of applications affected by this recording: 1 Total Fee (= # of apps x \$40.00) = \$40.00

Authorization is hereby given to charge the above to deposit account # 16-2497.

- 7. Execution date of the document to be recorded: 03/20/02
- 8. Total number of pages including cover sheet: 3
- 9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.
- 10. CERTIFICATE OF MAILING (37 CFR 1.10): I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as Express Mail in an envelope addressed to: Box New Applications, The Assistant Čommissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

20775 Norada Court

Saratoga, CA 95070-3018

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04/16/2002 DBYRNE 40.00 CH 01 FC:581

Recording Cover Sheet, Page 1 of 1

PATENT

REEL: 012781 FRAME: 0920

	<u>PATENT</u>
Docket No.:	

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR

Assignor's Name	Assignor's Residence and/or Address	Nationality
(1)		
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hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
Kingpak Technology Inc.	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan

and the successors, assigns and legal represe	entatives of the ASSIGNEE	icheck one of the fol	llowing]
The entire right, title, and interest	🗖 an undivided	percent (%) interest
in and to any and all improvements which as	re disclosed in the invention e	ntitled: PACKAGE STRU	ICTURE FOR A
PHOTOSENSITIVE CHIP	, and which is found in	[check one of the following]	
(a) DU.S. patent application executed on	3 ,1, 2002	•	
(b) 🗆 U.S. patent application serial number		, filed on	
(c) 🗖 U.S. patent number	, issued on		
and, in and to, all Letters Patent to be obt	tained for said invention by	the above application or any	continuation, division
renewal, or substitute thereof, and as to Lett	ers Patent any reissued or re-e	xamination thereof.	

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(1) Jasm Knowy	Jason CHUANG	3/9,2002
(2) A113 CHEN	Allis CHEN	3, 9, >00
(3) Takentsieh	Jachson HSIEH	3/8.202
(4) MGin Wen Tu	Hsiu Wen TU	3/19,2002
(5) Meng Ry Tsai	Meng Ru TSAI	3/19, 2002
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Docket No.:

ASSIGNMENT OF INVENTION

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hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
Kingpak Technology Inc.	No.84, Taiho Road, Chupei, Hsirichu Hsien, Taiwan	Taiwan

and the successors, assigns and legal represen	ntatives of the ASSIGNEE	[check one of the	following]
☐ the entire right, title, and interest	🗆 an undivided	percent (%) interest
in and to any and all improvements which are	e disclosed in the invention e	ntitled: PACKAGE STF	RUCTURE FOR A
PHOTOSENSITIVE CHIP	, and which is found in	[check one of the following	gJ
(a) 🗖 U.S. patent application executed on 🚅	, 17, 2002		
(b) \square U.S. patent application serial number $_$, filed on	
(c) 🗆 U.S. patent number	, issued on		
and, in and to, all Letters Patent to be obta	nined for said invention by	the above application or an	y continuation, division
renewal, or substitute thereof, and as to Lette	rs Patent any reissued or re-e	examination thereof	

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
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(10) Chih cheng HSU	Chih Cheng HSU	3/50,02

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